



IPOSIM Steady-State Calculation Report

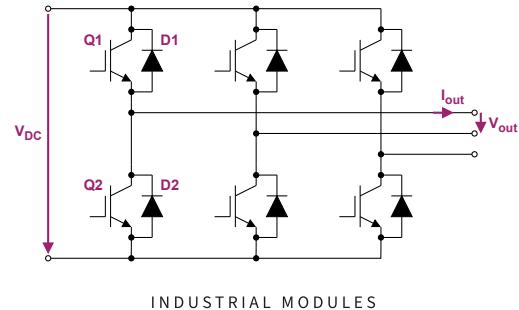
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Circuit & Control

Modulation algorithm	SVPWM
DC link voltage V_{DC}	1070 V
Output current I_{out}	370 Arms
Output frequency	15.6 Hz
Switching frequency	4000 Hz
Modulation index	0.85
Power factor $\cos(\phi)$	0.8
Output voltage V_{out}	557 V
Reactive power type	Inductive load (lagging) V



Three Phase - 2 Level

SWITCH
FF650R17IE4

IGBT parameters

V_{CEsat}	2.35 V
$E_{on} + E_{off}$	503.00 mWs
T_{vjmax}	150.00 °C
R_{thJC}	0.04 K/W
R_{thCH}	0.01 K/W

Diode parameters

V_F	1.95 V
E_{rec}	135.00 mWs
T_{vjmax}	150.00 °C
R_{thJC}	0.07 K/W
R_{thCH}	0.03 K/W

System parameters

Slew-rate gate control	Deactivated
Switch Q1: R_{Gon}	1.80 Ω
Switch Q1: R_{Goff}	2.70 Ω

Cooling conditions

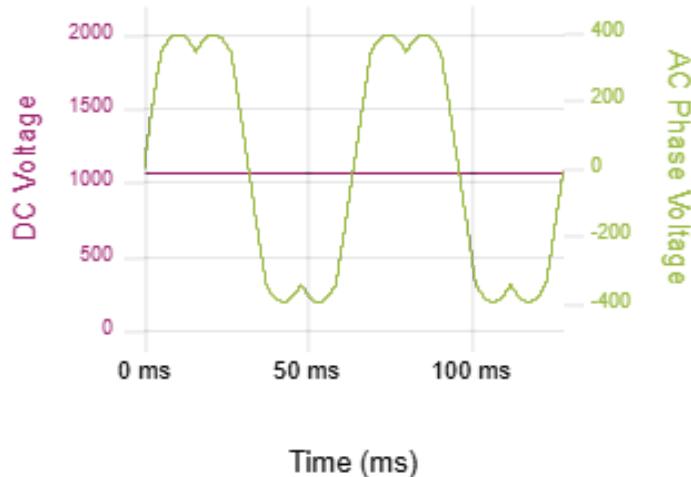
Heatsink model	User defined heatsink	
	Ambient temperature T_a	Heatsink parameters
40.00 °C	$R_{th,h}$ [K/W]	$\tau_{th,h}$ [s]
0.036	0.036	1
0	0	1
0	0	1
0	0	1



	SWITCH Q1	138.70 °C	242.10 W	610.20 W	852.30 W
	DIODE D1	116.10 °C	57.70 W	195.70 W	253.40 W
MAXIMUM JUNCTION TEMPERATURE			CONDUCTION LOSSES	SWITCHING LOSSES	TOTAL LOSSES

System Electrical

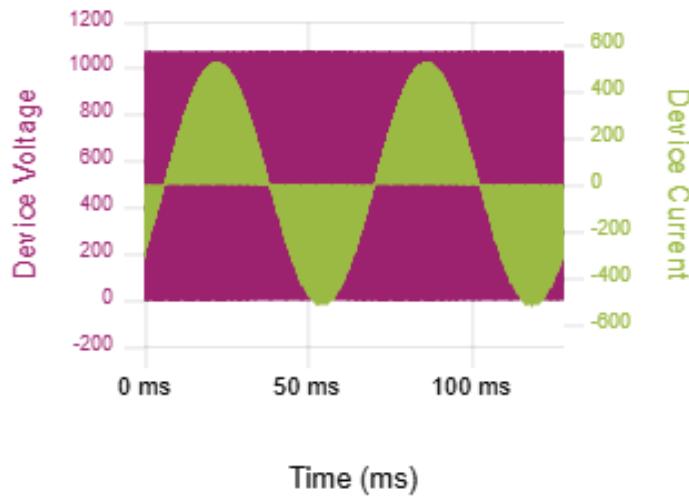
System Voltage





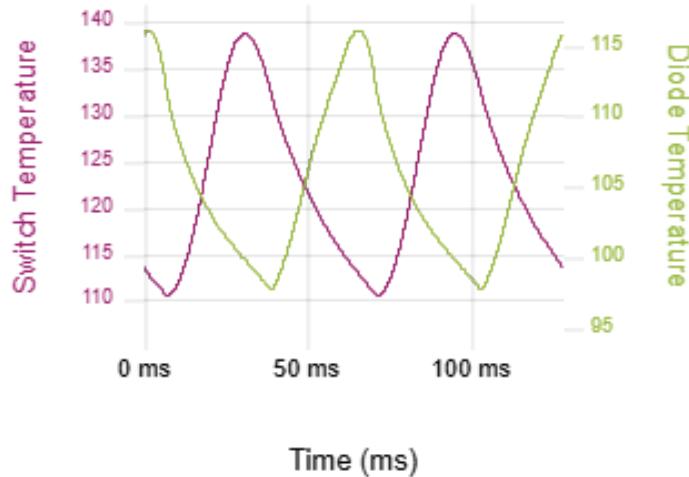
Device Electrical

Device Q1 Voltage and Current



Device Thermal

Device Q1 Temperature Ripple





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